This form will be used to improve the quality of future courses. Your frank comments are welcomed.

1. Overall, was the course a valuable learning experience? (circle one:)

<table>
<thead>
<tr>
<th>No</th>
<th>Very much so</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>2</td>
</tr>
</tbody>
</table>

Comments:

2. Did the course meet its stated objective? (circle one:)

<table>
<thead>
<tr>
<th>No</th>
<th>Very much so</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
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</tbody>
</table>

Comments:

3. What do you consider to be the main strengths of the course?

________________________________________________________________________

________________________________________________________________________

________________________________________________________________________

4. What do you consider to be the main weaknesses of the course as presented?

________________________________________________________________________

________________________________________________________________________

________________________________________________________________________

5. Would you recommend this course to your (circle one:)

Peers  (YES)  (NO)
Subordinates  (YES)  (NO)
Supervisors  (YES)  (NO)
6. Based on the class presentations, use the following scale to evaluate the subjects listed below:

<table>
<thead>
<tr>
<th>Below Average</th>
<th>Above Average</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>2</td>
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<tr>
<td>3</td>
<td>4</td>
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<td>5</td>
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<td>7</td>
<td>8</td>
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<td>9</td>
<td>10</td>
</tr>
</tbody>
</table>

___ S-1 Introduction/Course Overview/Policy and Procedures
___ S-2 General Requirements of J-STD-001E
___ S-3 Materials, Component, and Equipment Requirements
___ S-4 General Soldering and Assembly Requirements
___ S-5 PCB Requirements
___ S-6, 7 Cleaning Process Requirements, Progress Review (S-12, 16, 22)
___ S-8 Wire & Terminal Assembly/Soldering Requirements
___ S-9 Wire & Terminal Soldering Demonstration
___ S-10 Wire & Terminal Soldering Lab
___ S-11 Through-Hole Mounting and Termination Requirements
___ S-13 Through-Hole Assembly/Soldering Demonstrations
___ S-14 Through-Hole Soldering Lab
___ S-15 Surface Mounting of Components Requirements
___ S-17 Surface Mount Technology Assembly/Soldering Demonstrations
___ S-18 SMT Soldering Lab
___ S-19 Coating, Encapsulation and Staking (Adhesive)
___ S-20 Rework and Repair Requirements
___ S-21 Product Assurance Requirements
___ S-23 Instructor Skills
___ S-24 Comprehensive Review
___ S-25 Testing
___ S-26 Administrative Responsibilities of a CIT
Do you feel, based on the presentations in the class, that you have a more thorough understanding of the subjects listed above? (circle one:)  (YES)  (NO)

7. Did you find the instructor's presentation to be clear and effective? (circle one:)

    No                                           Very much so
    1 2 3 4 5 6 7 8 9 10

8. What could the instructor or training center have done to enhance your learning experience?

______________________________________________________________________
______________________________________________________________________
______________________________________________________________________